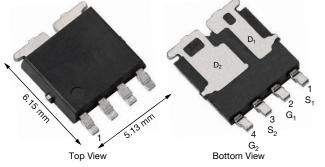


Vishay Siliconix

Automotive Dual N-Channel 20 V (D-S) 175 °C MOSFETs

| PRODUCT SUMMA | IARY | | | | | |
|---|----------------|-----------------|--|--|--|--|
| | N-CHANNEL 1 | N-CHANNEL 2 | | | | |
| V _{DS} (V) | 20 | 20 | | | | |
| $R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$ | 0.0088 | 0.0037 | | | | |
| $R_{DS(on)}$ (Ω) at V_{GS} = 4.5 V | 0.0124 | 0.0050 | | | | |
| I _D (A) | 20 | 60 | | | | |
| Configuration | Dua | al N | | | | |
| Package | PowerPAK SO-8L | Dual Asymmetric | | | | |

PowerPAK[®] SO-8L Dual Asymmetric

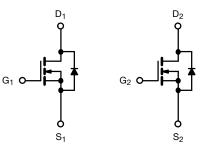


FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified ^d
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT HALOGEN FREE



N-Channel 1 MOSFET

N-Channel 2 MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _C = | = 25 °C, unless | s otherwise r | ioted) | | | |
|---|-------------------------|-----------------------------------|-----------------|-------------|------|--|
| PARAMETER | | SYMBOL | N-CHANNEL 1 | N-CHANNEL 2 | UNIT | |
| Drain-Source Voltage | | V _{DS} | 20 | 20 | V | |
| Gate-Source Voltage | V _{GS} | ± | V | | | |
| Continuous Drain Current ^a | $T_C = 25 \ ^\circ C$ | I. | 20 | 60 | | |
| Continuous Drain Current ~ | T _C = 125 °C | I _D | 20 | 50 | | |
| Continuous Source Current (Diode Conduction) | • | I _S | 20 ^a | 44 | A | |
| Pulsed Drain Current ^b | | I _{DM} | 80 | 180 | | |
| Single Pulse Avalanche Current | | I _{AS} | 22 | 40 | | |
| Single Pulse Avalanche Energy L = 0.1 mH | | E _{AS} | 24.2 | 80 | mJ | |
| Maximum Power Dissipation ^b | $T_C = 25 \ ^\circ C$ | Pn | 27 | 48 | W | |
| Maximum Fower Dissipation ~ | T _C = 125 °C | гD | 9 | 16 | vv | |
| Operating Junction and Storage Temperature Range | ł | T _J , T _{stg} | -55 to | +175 | °C | |
| Soldering Recommendations (Peak Temperature) e, f | | | 20 | 50 | | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------|------------------------|-------------------|-------------|-------------|------|
| PARAMETER | | SYMBOL | N-CHANNEL 1 | N-CHANNEL 2 | UNIT |
| Junction-to-Ambient | PCB mount ^c | R _{thJA} | 85 | 85 | °C/W |
| Junction-to-Case (Drain) | | R _{thJC} | 5.5 | 3.1 | 0/10 |

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.
- e. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

S15-2336-Rev. A, 05-Oct-15 1 Document Number: 67774
For technical questions, contact: automostechsupport@vishay.com
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIPTED HEREIN AND THE DOCUMENT.



Vishay Siliconix

| SPECIFICATIONS (T _C = 25 | L. | otherwise no | | | MIN. | 1 | 1 | r | |
|---|---|------------------------------------|--|--------|----------|--------|---------|----------|--|
| PARAMETER | SYMBOL | | TEST CONDITIONS | | | TYP. | MAX. | UNIT | |
| Static | 1 | | | | 1 | - | | T | |
| Drain-Source Breakdown Voltage | V _{DS} | | = 0 V, I _D = 250 μA | N-Ch 1 | 20 | - | - | | |
| | 50 | $V_{GS} = 0 V, I_D = 250 \mu A$ | | | 20 | - | - | v | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μΑ | N-Ch 1 | 1 | 1.5 | 2 | | |
| | • (3)(11) | V _{DS} = | = V _{GS} , I _D = 250 μΑ | N-Ch 2 | 1 | 1.5 | 2 | | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | N-Ch 1 | - | - | ± 100 | nA | |
| Gate Couloe Leanage | 'GSS | •DS - | • • •, • GS = ± 20 • | N-Ch 2 | - | - | ± 100 | 103 | |
| | | $V_{GS} = 0 V$ | $V_{DS} = 20 V$ | N-Ch 1 | - | - | 1 | | |
| | | $V_{GS} = 0 V$ | $V_{DS} = 20 V$ | N-Ch 2 | - | - | 1 | | |
| Zero Gate Voltage Drain Current | 1 | $V_{GS} = 0 V$ | $V_{DS} = 20 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ | N-Ch 1 | - | - | 50 | | |
| Zero Gale Voltage Drain Gurrent | IDSS | $V_{GS} = 0 V$ | $V_{DS} = 20 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ | N-Ch 2 | - | - | 50 | μA | |
| | | $V_{GS} = 0 V$ | $V_{DS} = 20 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$ | N-Ch 1 | - | - | 150 | | |
| | | V _{GS} = 0 V | V _{DS} = 20 V, T _J = 175 °C | N-Ch 2 | - | - | 150 | | |
| On Otata Ducia Orumanta | | V _{GS} = 10 V | $V_{DS} \ge 5 V$ | N-Ch 1 | 20 | - | - | • | |
| On-State Drain Current ^a | I _{D(on)} | V _{GS} = 10 V | $V_{DS} \ge 5 V$ | N-Ch 2 | 30 | - | - | A | |
| | | V _{GS} = 10 V | I _D = 16 A | N-Ch 1 | - | 0.0074 | 0.0088 | | |
| | | V _{GS} = 10 V | I _D = 20 A | N-Ch 2 | - | 0.0031 | 0.0037 | | |
| unia Danuara Da Otata Daniatanan A | | V _{GS} = 10 V | I _D = 16 A, T _J = 125 °C | N-Ch 1 | - | 0.0110 | - | | |
| | _ | V _{GS} = 10 V | I _D = 20 A, T _J = 125 °C | N-Ch 2 | - | 0.0036 | - | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V | I _D = 16 A, T _J = 175 °C | N-Ch 1 | - | 0.0124 | - | Ω | |
| | | V _{GS} = 10 V | I _D = 20 A, T _J = 175 °C | N-Ch 2 | - | 0.0063 | - | - | |
| | | V _{GS} = 4.5 V | I _D = 14 A | N-Ch 1 | - | 0.0095 | 0.0124 | | |
| | | V _{GS} = 4.5 V | I _D = 19 A | N-Ch 2 | - | 0.0039 | 0.0050 | - | |
| | | V _{DS} | = 10 V, I _D = 10 A | N-Ch 1 | - | 55 | - | | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} | = 10 V, I _D = 10 A | N-Ch 2 | - | 60 | - | S | |
| Dynamic ^b | | | | 1 | <u> </u> | | | <u> </u> | |
| | | V _{GS} = 0 V | V _{DS} = 10 V, f = 1 MHz | N-Ch 1 | - | 723 | 975 | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V | V _{DS} = 10 V, f = 1 MHz | N-Ch 2 | - | 1937 | 2525 | - | |
| | | V _{GS} = 0 V | V _{DS} = 10 V, f = 1 MHz | N-Ch 1 | - | 269 | 675 | | |
| Output Capacitance | C _{oss} | V _{GS} = 0 V | V _{DS} = 10 V, f = 1 MHz | N-Ch 2 | - | 655 | 870 | pF | |
| | $V_{GS} = 0 V \qquad V_{DS} = 10 V, f = 1 \text{ MHz} \qquad N-Ch 2 \qquad - \qquad 655$ $V_{GS} = 0 V \qquad V_{DS} = 10 V, f = 1 \text{ MHz} \qquad N-Ch 1 \qquad - \qquad 112$ | | V _{DS} = 10 V, f = 1 MHz | - | - | 112 | 340 | | |
| Reverse Transfer Capacitance | | | 350 | | | | | | |
| | | V _{GS} = 10 V | V _{DS} = 10 V, I _D = 20 A | N-Ch 1 | - | 12 | 18 | | |
| Total Gate Charge ^c | Qg | V _{GS} = 10 V | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 60 \text{ A}$ | N-Ch 2 | - | 29 | 43 | 1 | |
| | | V _{GS} = 10 V | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ | N-Ch 1 | - | 1.6 | - | nC | |
| Gate-Source Charge ^c | Q _{gs} | V _{GS} = 10 V | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 60 \text{ A}$ | N-Ch 2 | - | 4.1 | - | nC | |
| | | V _{GS} = 10 V | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ | N-Ch 1 | - | 2.5 | - | 1 | |
| Gate-Drain Charge ^c | Q _{gd} | $V_{GS} = 10 V$ $V_{GS} = 10 V$ | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 60 \text{ A}$ | N-Ch 2 | - | 6 | _ | - | |
| | | ·us - 10 V | - D5 - 10 7, ID - 00 A | N-Ch 1 | 1.1 | 2.3 | 3.5 | | |
| Gate Resistance | R _g | | f = 1 MHz | N-Ch 2 | 0.4 | 1 | 1.4 | Ω | |
| | | | | | 0.4 | | 1.4 | | |

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2



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SQJ200EP

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| SPECIFICATIONS (T _C = | 25 °C, unless o | therwise noted) | | | | | | |
|----------------------------------|-----------------------|---|--------|---------|------|------|----------------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT | |
| | | $\begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.3 \ \Omega \\ I_D \cong 20 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$ | N-Ch 1 | - | 4 | 6 | | |
| Turn-On Delay Time ^c | t _{d(on)} - | $\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.1 \ \Omega \\ I_D \cong 60 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$ | N-Ch 2 | - | 7 | 9 | | |
| | + | $\begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.3 \ \Omega \\ I_D \cong 20 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$ | N-Ch 1 | - | 18 | 23 | | |
| Rise Time ^c | t _r - | $\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 6 \ V, \ R_{\text{L}} = 0.1 \ \Omega \\ I_{\text{D}} \cong 60 \ A, \ V_{\text{GEN}} = 10 \ V, \ R_{\text{g}} = 1 \ \Omega \end{array}$ | N-Ch 2 | - | 17 | 23 | NIT Ns A | |
| | | $\begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.3 \ \Omega \\ I_D \cong 20 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$ | N-Ch 1 | - 13 17 | | 115 | | |
| Turn-Off Delay Time ^c | t _{d(off)} - | $\begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.1 \ \Omega \\ I_D \cong 60 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$ | N-Ch 2 | - | 19 | 25 | | |
| Fall Time ^c | + | $\begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.3 \ \Omega \\ I_D \cong 20 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$ | N-Ch 1 | - | 13 | 17 | | |
| | t _f - | $\label{eq:VDD} \begin{array}{l} V_{DD} = 6 \ V, \ R_L = 0.1 \ \Omega \\ I_D \cong 60 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \end{array}$ | N-Ch 2 | - | 14 | 28 | I | |
| Source-Drain Diode Ratings a | nd Characteristics | b | | | | | | |
| Pulsed Current ^a | 1 | | N-Ch 1 | - | - | 80 | _ | |
| | I _{SM} | | N-Ch 2 | - | - | 180 | | |
| Forward Valtage | N/ | $I_F = 10 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$ | N-Ch 1 | - | 0.8 | 1.2 | V | |
| Forward Voltage | V _{SD} | $I_F = 20 \text{ A}, V_{GS} = 0 \text{ V}$ | N-Ch 2 | - | 0.8 | 1.2 | | |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

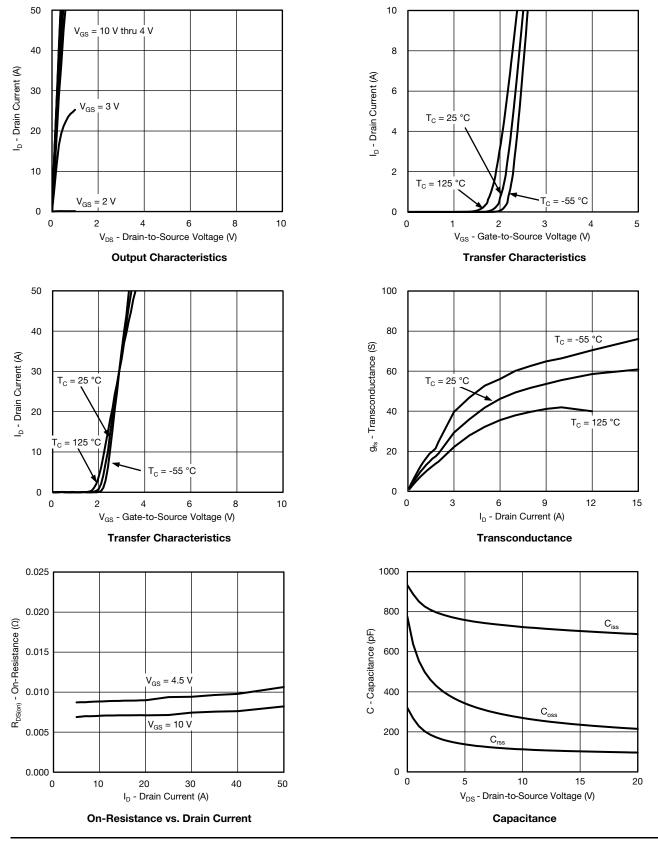
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

3



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N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



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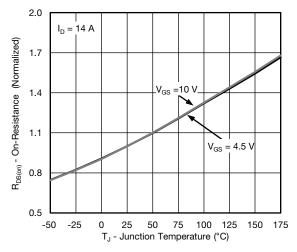
4

Document Number: 67774

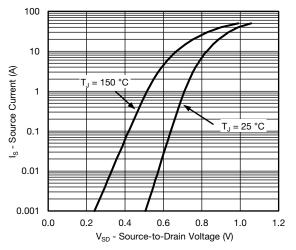




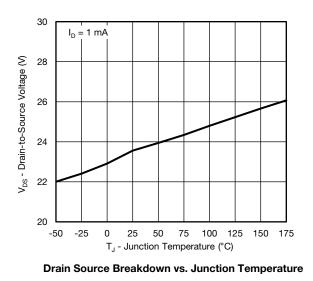
N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



On-Resistance vs. Junction Temperature

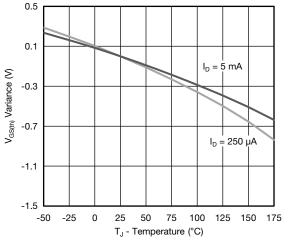


Source Drain Diode Forward Voltage

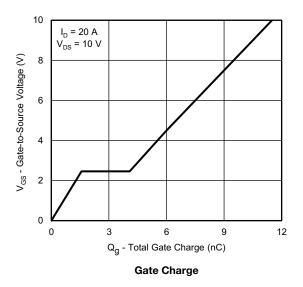




On-Resistance vs. Gate-to-Source Voltage







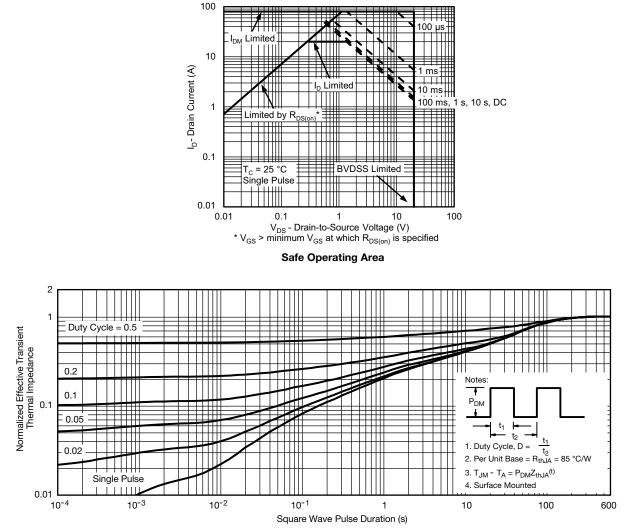
S15-2336-Rev. A, 05-Oct-15

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Document Number: 67774



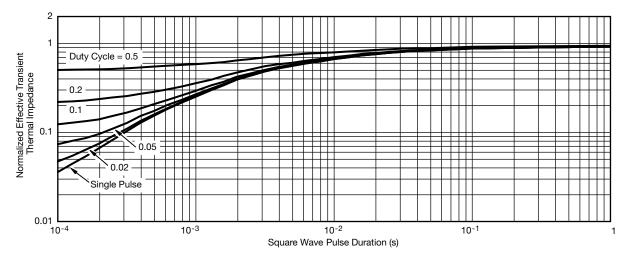
N-CHANNEL 1 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



N-CHANNEL 1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the graph:

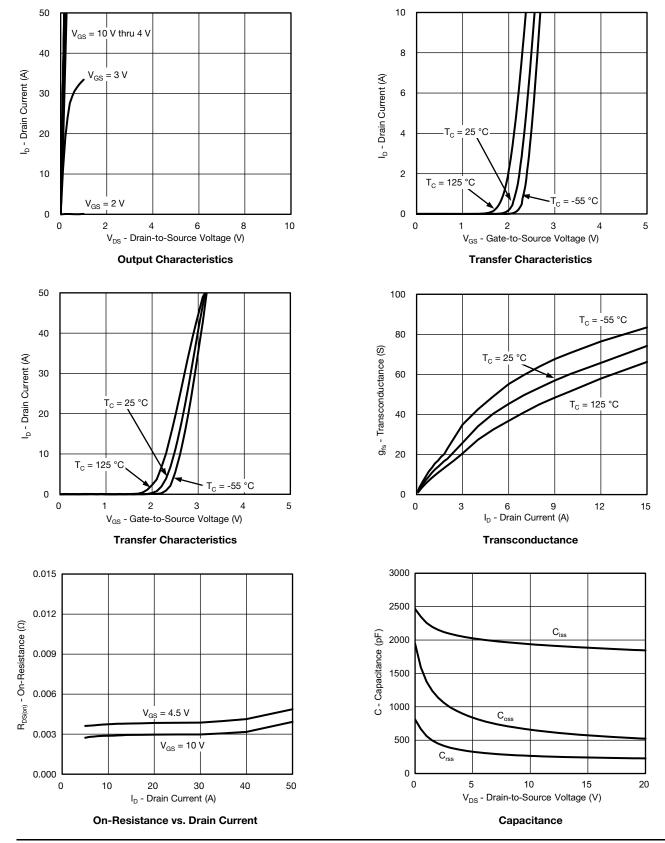
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

is given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



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N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



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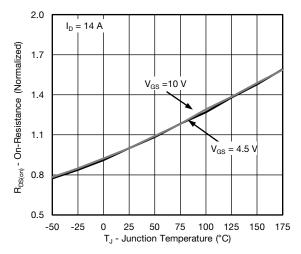
8

Document Number: 67774

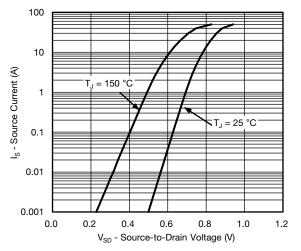




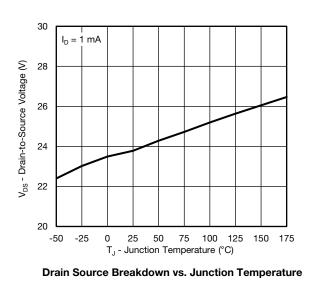
N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

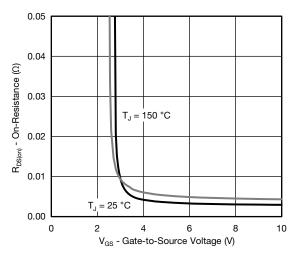


On-Resistance vs. Junction Temperature

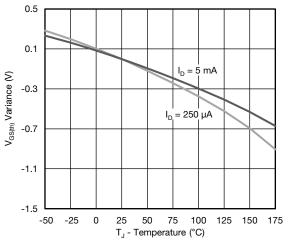


Source Drain Diode Forward Voltage

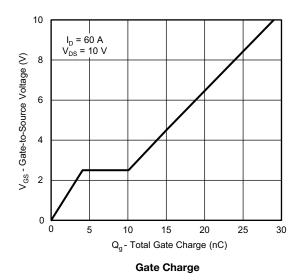


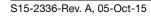


On-Resistance vs. Gate-to-Source Voltage





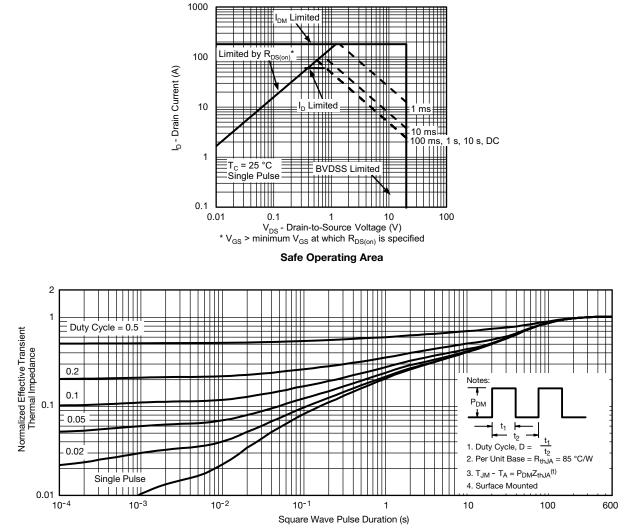




9 s. contact: automostech



N-CHANNEL 2 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

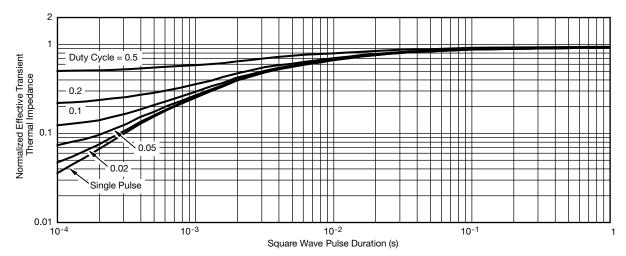


Normalized Thermal Transient Impedance, Junction-to-Ambient



Document Number: 67774

N-CHANNEL 2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the graph:

S15-2336-Rev. A, 05-Oct-15

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

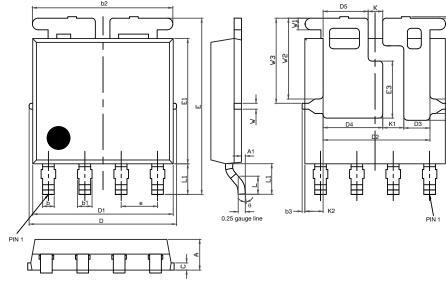
is given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?67774</u>.

11



PowerPAK[®] SO-8L Assymetric Case Outline



| DIM. | | MILLIMETERS | | | INCHES | | | |
|-------|------|-------------|------|-------|--------|-------|--|--|
| DINI. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | | |
| А | 1.00 | 1.07 | 1.14 | 0.039 | 0.042 | 0.045 | | |
| A1 | 0.00 | 0.06 | 0.13 | 0.000 | 0.003 | 0.005 | | |
| b | 0.33 | 0.41 | 0.48 | 0.013 | 0.016 | 0.019 | | |
| b1 | 0.44 | 0.51 | 0.58 | 0.017 | 0.020 | 0.023 | | |
| b2 | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 | | |
| b3 | 0.04 | 0.12 | 0.20 | 0.002 | 0.005 | 0.008 | | |
| С | 0.20 | 0.25 | 0.30 | 0.008 | 0.010 | 0.012 | | |
| D | 5.00 | 5.13 | 5.25 | 0.197 | 0.202 | 0.207 | | |
| D1 | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 | | |
| D2 | 3.63 | 3.73 | 3.83 | 0.143 | 0.147 | 0.151 | | |
| D3 | 0.81 | 0.91 | 1.01 | 0.032 | 0.036 | 0.040 | | |
| D4 | 1.98 | 2.08 | 2.18 | 0.078 | 0.082 | 0.086 | | |
| D5 | 1.47 | 1.57 | 1.67 | 0.058 | 0.062 | 0.066 | | |
| е | 1.20 | 1.27 | 1.34 | 0.047 | 0.050 | 0.053 | | |
| E | 6.05 | 6.15 | 6.25 | 0.238 | 0.242 | 0.246 | | |
| E1 | 4.27 | 4.37 | 4.47 | 0.168 | 0.172 | 0.176 | | |
| E2 | 2.75 | 2.85 | 2.95 | 0.108 | 0.112 | 0.116 | | |
| E3 | 1.89 | 1.99 | 2.09 | 0.074 | 0.078 | 0.082 | | |
| F | 0.05 | 0.12 | 0.19 | 0.002 | 0.005 | 0.007 | | |
| L | 0.62 | 0.72 | 0.82 | 0.024 | 0.028 | 0.032 | | |
| L1 | 0.92 | 1.07 | 1.22 | 0.036 | 0.042 | 0.048 | | |
| К | 0.41 | 0.51 | 0.61 | 0.016 | 0.020 | 0.024 | | |
| K1 | 0.64 | 0.74 | 0.84 | 0.025 | 0.029 | 0.033 | | |
| K2 | 0.54 | 0.64 | 0.74 | 0.021 | 0.025 | 0.029 | | |
| W | 0.13 | 0.23 | 0.33 | 0.005 | 0.009 | 0.013 | | |
| W1 | 0.31 | 0.41 | 0.51 | 0.012 | 0.016 | 0.020 | | |
| W2 | 2.72 | 2.82 | 2.92 | 0.107 | 0.111 | 0.115 | | |
| W3 | 2.86 | 2.96 | 3.06 | 0.113 | 0.117 | 0.120 | | |
| W4 | 0.41 | 0.51 | 0.61 | 0.016 | 0.020 | 0.024 | | |
| θ | 5° | 10° | 12° | 5° | 10° | 12° | | |

DWG: 6009

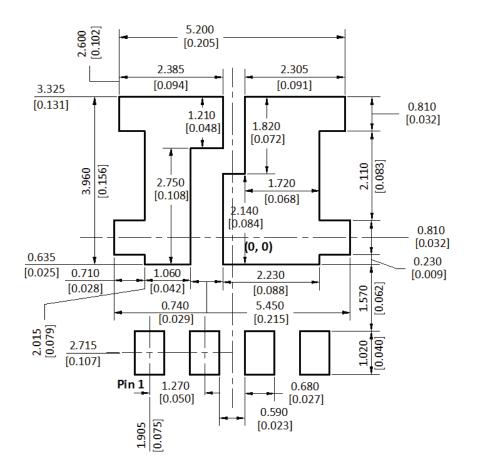
Note

• Millimeters will govern

C14-0057-Rev. D, 07-Apr-14



RECOMMENDED MINIMUM PADs FOR PowerPAK® SO-8L DUAL ASYMMETRIC



Recommended Minimum Pads Dimensions in mm [inches]



Vishay

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